



## **ULTRAFAST SOFT RECOVERY RECTIFIER DIODE**

## **PRODUCT APPLICATIONS**

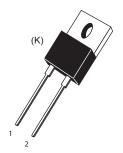
- Anti-Parallel Diode
  - -Switchmode Power Supply
  - -Inverters
- · Free Wheeling Diode
  - -Motor Controllers
  - -Converters
  - -Inverters
- · Snubber Diode
- PFC

## **PRODUCT FEATURES**

- · Ultrafast Recovery Times
- · Soft Recovery Characteristics
- · Popular TO-220 Package
- Low Forward Voltage
- · Low Leakage Current
- · Avalanche Energy Rated

## **PRODUCT BENEFITS**

- Low Losses
- · Low Noise Switching
- · Cooler Operation
- · Higher Reliability Systems
- Increased System Power Density





- 1 Cathode
- 2 Anode
  - Back of Case Cathode

#### MAXIMUM RATINGS

# All Ratings: $T_C = 25^{\circ}C$ unless otherwise specified.

Symbol	Characteristic / Test Conditions	APT30DQ100K(G)	UNIT
V <sub>R</sub>	Maximum D.C. Reverse Voltage		
V <sub>RRM</sub>	Maximum Peak Repetitive Reverse Voltage	1000	Volts
V <sub>RWM</sub>	Maximum Working Peak Reverse Voltage		
I <sub>F(AV)</sub>	Maximum Average Forward Current (T <sub>C</sub> = 102°C, Duty Cycle = 0.5)	30	
I <sub>F(RMS)</sub>	RMS Forward Current (Square wave, 50% duty)	43	Amps
I <sub>FSM</sub>	Non-Repetitive Forward Surge Current $(T_J = 45^{\circ}C, 8.3 \text{ms})$	150	
E <sub>AVL</sub>	Avalanche Energy (1A, 40mH)	20	mJ
$T_J, T_{STG}$	Operating and StorageTemperature Range	-55 to 175	°C
T <sub>L</sub>	Lead Temperature for 10 Sec.	300	

## STATIC ELECTRICAL CHARACTERISTICS

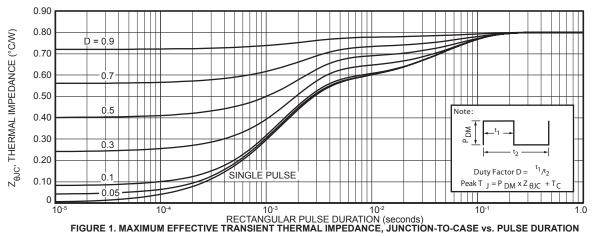
Symbol	Characteristic / Test Conditions		MIN	TYP	MAX	UNIT
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 30A		2.5	3.0	Volts
		I <sub>F</sub> = 60A		3.06		
		I <sub>F</sub> = 30A, T <sub>J</sub> = 125°C		1.92		
I <sub>RM</sub>	Maximum Reverse Leakage Current	V <sub>R</sub> = 1000V			100	μA
		V <sub>R</sub> = 1000V, T <sub>J</sub> = 125°C			500	
C <sub>T</sub>	Junction Capacitance, V <sub>R</sub> = 200V			26		pF

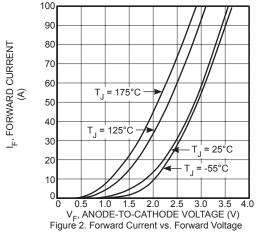
Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
t <sub>rr</sub>	Reverse Recovery Time $I_F = 1A$ , $di_F/dt =$	$I_F = 1A$ , $di_F/dt = -100A/\mu s$ , $V_R = 30V$ , $T_J = 25^{\circ}C$		24		ns
t <sub>rr</sub>	Reverse Recovery Time	$I_F = 30A$ , $di_F/dt = -200A/\mu s$ $V_R = 667V$ , $T_C = 25^{\circ}C$	-	295		115
Q <sub>rr</sub>	Reverse Recovery Charge		-	440		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current		-	4	-	Amps
t <sub>rr</sub>	Reverse Recovery Time	$I_F = 30A$ , $di_F/dt = -200A/\mu s$ $V_R = 667V$ , $T_C = 125°C$	-	330		ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	1550		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current		-	8	-	Amps
t <sub>rr</sub>	Reverse Recovery Time	$I_F = 30A$ , $di_F/dt = -1000A/\mu s$ $V_R = 667V$ , $T_C = 125°C$	-	150		ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	2250		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current		-	25		Amps

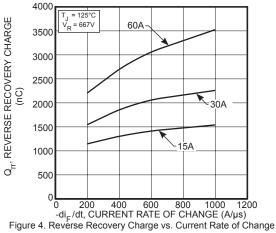
#### THERMAL AND MECHANICAL CHARACTERISTICS

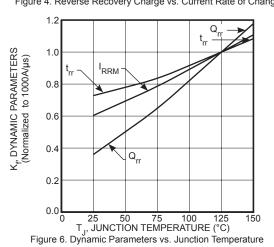
Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction-to-Case Thermal Resistance			.80	°C/W
W <sub>T</sub>	Package Weight		0.07		oz
			1.9		g
Torque	Maximum Mounting Torque			10	lb•in
				1.1	N•m

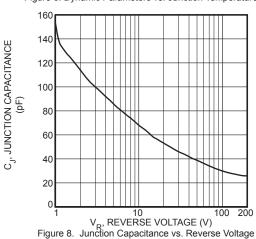
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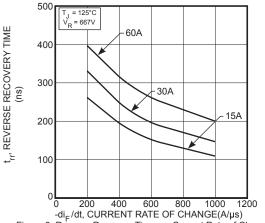
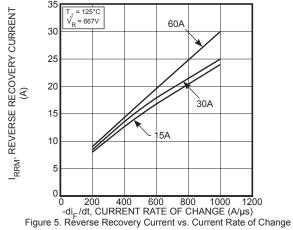


Figure 3. Reverse Recovery Time vs. Current Rate of Change



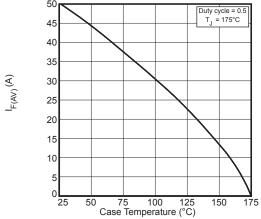


Figure 7. Maximum Average Forward Current vs. CaseTemperature

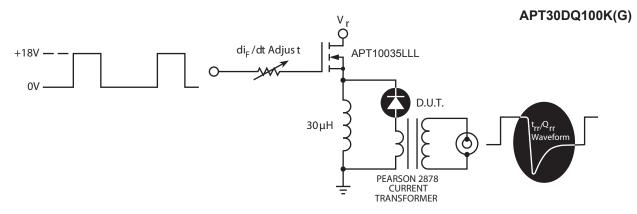
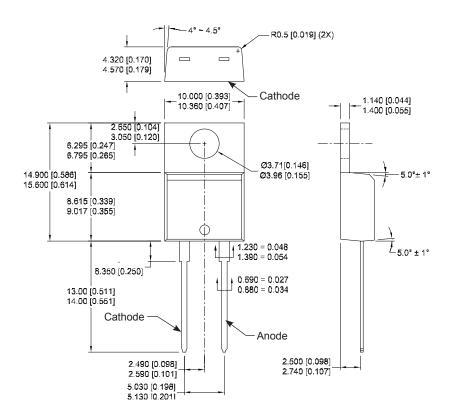


Figure 9. Diode Test Circuit

- I<sub>F</sub> Forward Conduction Current
- 2 di<sub>-</sub>/dt Rate of Diode Current Change Through Zero Crossing.
- 3 I<sub>RRM</sub> Maximum Reverse Recovery Current
- 4 t<sub>rr</sub> Reverse Recovery Time measured from zero crossing where diode current goes from positive to negative, to the point at which the straight line through I<sub>RRM</sub> and 0.25, I<sub>RRM</sub> passes through zero.
- $\mathbf{5}$   $\mathbf{Q}_{\mathrm{rr}}$  Area Under the Curve Defined by  $\mathbf{I}_{\mathrm{RRM}}$  and  $\mathbf{t}_{\mathrm{RR}}$ .

Figure 10. Diode Reverse Recovery Waveform Definition

#### TO-220 (K) Package Outline e3 100% Sn



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